

Film Capacitors

Metallized Polypropylene Film Capacitors (MFP)

Series/Type: B32686A Date: December 2012

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Metallized polypropylene film capacitors (MFP)

Very high pulse (wound)

Typical applications

- Smoothing
- Snubbering
- High-frequency AC loads

Climatic

- Max. operating temperature: 110 °C
- Climatic category (IEC 60068-1): 55/100/56

Construction

- Dielectric: polypropylene (PP)
- Film metallized on one side and metal foils internally connected in series
- Plastic case (UL 94 V-0)
- Epoxy resin sealing (UL 94 V-0)

Features

- Very high pulse strength
- Highest possible contact reliability
- Self-healing properties
- RoHS-compatible

Terminals

- Parallel wire leads, lead-free tinned
- Special lead lengths available on request

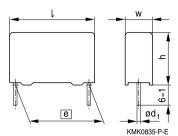
Marking

Manufacturer's logo, series number, style (MFP), rated capacitance, capacitance tolerance (code letter), rated DC voltage, date of manufacture (coded)

Delivery mode

Bulk (untaped)

Dimensional drawing



Dimensions in mm

Lead spacing	Lead diameter	Туре
<i>e</i> ±0.4	d ₁	
37.5	1.0	B32686A

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Overview of available types

Lead spacing	37.5 mm			
Туре	B32686A			
V _R (V DC)	1000	1250	1600	2000
V _{RMS} (V AC)	400	450	450	500
C _R (nF)				
22				
33				
47				
68				
100				
150				
220				
330				
470				





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Ordering codes and packing units (lead spacing 37.5 mm)

V _R	V _{RMS}	C _R	Max. dimensions	Ordering code	Untaped
	f≤1 kHz		$w \times h \times l$	(composition see	
V DC	V AC	nF	mm	below)	pcs./MOQ
1000	400	68	$12.0\times22.5\times42.0$	B32686A0683+000	288
		100	$12.0\times22.5\times42.0$	B32686A0104+000	288
		150	$14.0 \times 25.0 \times 42.0$	B32686A0154+000	224
		220	$16.0 \times 28.5 \times 42.0$	B32686A0224+000	192
		330	$20.0\times39.5\times42.0$	B32686A0334+000	128
		470	$20.0\times39.5\times42.0$	B32686A0474+000	128
1250	450	68	$12.0\times22.5\times42.0$	B32686A7683+000	288
		100	$14.0 \times 25.0 \times 42.0$	B32686A7104+000	224
		150	$16.0 \times 28.5 \times 42.0$	B32686A7154+000	192
		220	$18.0\times32.5\times42.0$	B32686A7224+000	192
		330	$20.0\times39.5\times42.0$	B32686A7334+000	128
1600	450	47	$12.0\times22.5\times42.0$	B32686A1473+000	288
		68	$14.0 \times 25.0 \times 42.0$	B32686A1683+000	224
		100	$18.0\times32.5\times42.0$	B32686A1104+000	192
		150	$20.0\times39.5\times42.0$	B32686A1154+000	128
2000	500	22	$12.0\times22.5\times42.0$	B32686A2223+000	288
		33	$14.0 \times 25.0 \times 42.0$	B32686A2333+000	224
		47	$16.0 \times 28.5 \times 42.0$	B32686A2473+000	192
		68	$18.0\times32.5\times42.0$	B32686A2683+000	192
		100	$20.0\times39.5\times42.0$	B32686A2104+000	128

MOQ = Minimum Order Quantity, consisting of 4 packing units.

Further E series and intermediate capacitance values on request.

Composition of ordering code

+ = Capacitance tolerance code:

 $K = \pm 10\%$

 $J = \pm 5\%$



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Technical data

Operating temperature range	Max. operating temperature $T_{op,max}$		+110 °C
	Upper category temperature T _{max}		+100 °C
	Lower category temperature T _{min}		−55 °C
	Rated temperature T _R		+85 °C
Dissipation factor tan δ (in 10 ⁻³)	at	$C_{\text{R}} \leq 0.1 \; \mu F$	C _R > 0.1 μF
at 20 °C	1 kHz	-	0.4
(upper limit values)	10 kHz	0.4	0.5
	100 kHz	1.0	-
Insulation resistance R _{ins}	C _R ≤0.33 μF	C _R > 0.33 μF	
or time constant $\tau = C_R \cdot R_{ins}$	100 GΩ	30 000 s	
at 20 °C, rel. humidity \leq 65%			
(minimum as-delivered values)			
DC test voltage	2.0 · V _B , 2 s	3	
Category voltage V _c	T _A (°C)	DC voltage derating	AC voltage derating
(continuous operation with V_{DC}	$T_A \le 85$	$V_{c} = V_{R}$	V _{C.RMS} =V _{RMS}
or V_{AC} at f \leq 1 kHz)	85 <t<sub>A≤100</t<sub>	$V_{c} = V_{R} \cdot (165 - T_{A})/80$	$V_{C,RMS} = V_{RMS} \cdot (165 - T_A)/80$
Operating voltage V _{op}	T _A (°C)	DC voltage (max. hours) AC voltage (max. hours)
for short operating periods	$T_A \le 85$	$V_{op} = 1.25 \cdot V_{C} (2000 \text{ h})$	$V_{op} = 1.0 \cdot V_{C,RMS} (2000 \text{ h})$
V_{DC} or V_{AC} at f \leq 1 kHz)	85 <t<sub>A≤100</t<sub>	$V_{op} = 1.25 \cdot V_{C} (1000 \text{ h})$	$V_{op} = 1.0 \cdot V_{C,RMS} (1000 \text{ h})$
Damp heat test	56 days/40	°C/93% relative humidity	
Limit values after damp	Capacitance	e change ∆C/C	≤2%
heat test	Dissipation	factor change Δ tan δ	≤ 1.0 · 10 [.] 3 (at 10 kHz)
	Insulation re	esistance R _{ins}	≥ 50% of minimum
	or time cons	stant $\tau = C_R \cdot R_{ins}$	as-delivered values
Reliability:			
Failure rate λ	1 fit (≤ 1 · 1	0 [.] /h) at 0.5 · V _B , 40 °C	
Service life t _{sL}	200 000 h a	tt 1.0 · V _R , 85 °C	
	For convers	ion to other operating co	nditions and temperatures,
		pter "Quality, 2 Reliability	
Failure criteria:			
Total failure	Short circuit or open circuit		
Failure due to variation	Capacitance	e change ∆C/C	> 10%
of parameters	Dissipation	factor tan δ	4 · upper limit value
	Insulation re	esistance R _{ins}	< 1500 M Ω (C _R \leq 0.33 μ F)
	or time cons	stant $\tau = C_R \cdot R_{ins}$	< 500 s (C _R > 0.33 µF)





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Pulse handling capability

"dV/dt" represents the maximum permissible voltage change per unit of time for non-sinusoidal voltages, expressed in $V/\mu s$.

"k_0" represents the maximum permissible pulse characteristic of the waveform applied to the capacitor, expressed in V²/µs.

Note:

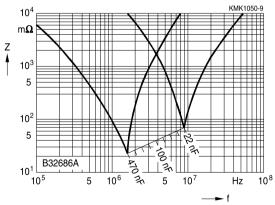
The values of dV/dt and k_0 provided below must not be exceeded in order to avoid damaging the capacitor.

dV/dt and k₀ values

Lead spacing		37.5 mm		
V _R (V DC)	V _{RMS} (V AC)	dV/dt in V/µs	k ₀ in V²/μs	
1000	400	2 000	4 000 000	
1250	450	2 800	7 000 000	
1600	450	3 500	11 000 000	
2000	500	4 500	18 000 000	

Impedance Z versus frequency f

(typical values)

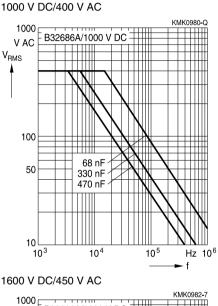




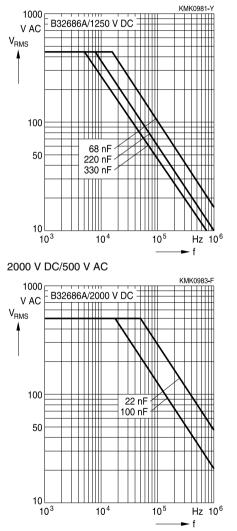
Permissible AC voltage V_{RMS} versus frequency f (for sinusoidal waveforms, T_A ${\leq}90~^\circ\text{C}$)

For T_A >90 °C, please refer to "General technical information", section 3.2.3.

Lead spacing 37.5 mm



 V_{AC} = B32686A/1600 V DC V_{RMS} = 100 100 100 100 101 103 10⁴ 10⁵ Hz 10⁶ 1250 V DC/450 V AC







Mounting guidelines

1 Soldering

1.1 Solderability of leads

The solderability of terminal leads is tested to IEC 60068-2-20, test Ta, method 1.

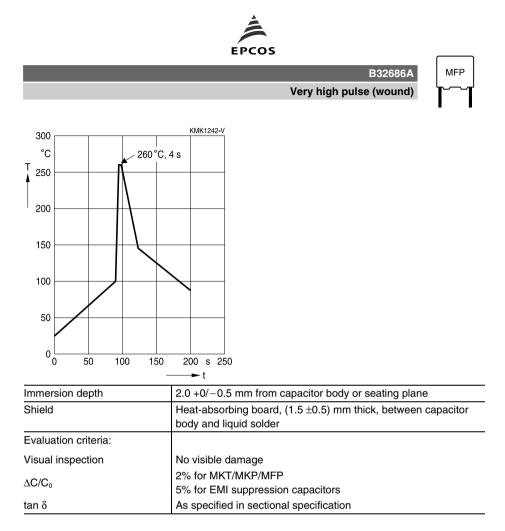
Before a solderability test is carried out, terminals are subjected to accelerated ageing (to IEC 60068-2-2, test Ba: 4 h exposure to dry heat at 155 °C). Since the ageing temperature is far higher than the upper category temperature of the capacitors, the terminal wires should be cut off from the capacitor before the ageing procedure to prevent the solderability being impaired by the products of any capacitor decomposition that might occur.

Solder bath temperature	235 ±5 °C
Soldering time	2.0 ±0.5 s
Immersion depth	2.0 + 0/-0.5 mm from capacitor body or seating plane
Evaluation criteria:	
Visual inspection	Wetting of wire surface by new solder \ge 90%, free-flowing solder

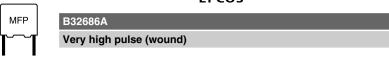
1.2 Resistance to soldering heat

Resistance to soldering heat is tested to IEC 60068-2-20, test Tb, method 1A. Conditions:

Serie	S	Solder bath temperature	Soldering time
MKT	boxed (except $2.5 \times 6.5 \times 7.2$ mm) coated uncoated (lead spacing > 10 mm)	260 ±5 °C	10 ±1 s
MFP MKP	(lead spacing > 7.5 mm)		
MKT	boxed (case $2.5 \times 6.5 \times 7.2$ mm)		5±1 s
МКР МКТ	(lead spacing \leq 7.5 mm) uncoated (lead spacing \leq 10 mm) insulated (B32559)		< 4 s recommended soldering profile for MKT uncoated (lead spacing \leq 10 mm) and insulated (B32559)







1.3 General notes on soldering

Permissible heat exposure loads on film capacitors are primarily characterized by the upper category temperature T_{max} . Long exposure to temperatures above this type-related temperature limit can lead to changes in the plastic dielectric and thus change irreversibly a capacitor's electrical characteristics. For short exposures (as in practical soldering processes) the heat load (and thus the possible effects on a capacitor) will also depend on other factors like:

- Pre-heating temperature and time
- Forced cooling immediately after soldering
- Terminal characteristics:
- diameter, length, thermal resistance, special configurations (e.g. crimping)
- Height of capacitor above solder bath
- Shadowing by neighboring components
- Additional heating due to heat dissipation by neighboring components
- Use of solder-resist coatings

The overheating associated with some of these factors can usually be reduced by suitable countermeasures. For example, if a pre-heating step cannot be avoided, an additional or reinforced cooling process may possibly have to be included.

EPCOS recommends the following conditions:

- Pre-heating with a maximum temperature of 110 °C
- Temperature inside the capacitor should not exceed the following limits:
 - MKP/MFP 110 °C
 - MKT 160 °C
- When SMD components are used together with leaded ones, the leaded film capacitors should not pass into the SMD adhesive curing oven. The leaded components should be assembled after the SMD curing step.
- Leaded film capacitors are not suitable for reflow soldering.

Uncoated capacitors

For uncoated MKT capacitors with lead spacings \leq 10 mm (B32560/B32561) the following measures are recommended:

- pre-heating to not more than 110 °C in the preheater phase
- rapid cooling after soldering



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Cautions and warnings

- Do not exceed the upper category temperature (UCT).
- Do not apply any mechanical stress to the capacitor terminals.
- Avoid any compressive, tensile or flexural stress.
- Do not move the capacitor after it has been soldered to the PC board.
- Do not pick up the PC board by the soldered capacitor.
- Do not place the capacitor on a PC board whose PTH hole spacing differs from the specified lead spacing.
- Do not exceed the specified time or temperature limits during soldering.
- Avoid external energy inputs, such as fire or electricity.
- Avoid overload of the capacitors.

The table below summarizes the safety instructions that must always be observed. A detailed description can be found in the relevant sections of the chapters "General technical information" and "Mounting guidelines".

Торіс	Safety information	Reference chapter "General technical information"
Storage conditions	Make sure that capacitors are stored within the specified range of time, temperature and humidity conditions.	4.5 "Storage conditions"
Flammability	Avoid external energy, such as fire or electricity (passive flammability), avoid overload of the capacitors (active flammability) and consider the flammability of materials.	5.3 "Flammability"
Resistance to vibration	Do not exceed the tested ability to withstand vibration. The capacitors are tested to IEC 60068-2-6. EPCOS offers film capacitors specially designed for operation under more severe vibration regimes such as those found in automotive applications. Consult our catalog "Film Capacitors for Automotive Electronics".	5.2 "Resistance to vibration"



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Торіс	Safety information	Reference chapter "Mounting guidelines"
Soldering	Do not exceed the specified time or temperature limits during soldering.	1 "Soldering"
Cleaning	Use only suitable solvents for cleaning capacitors.	2 "Cleaning"
Embedding of capacitors in finished assemblies	When embedding finished circuit assemblies in plastic resins, chemical and thermal influences must be taken into account. Caution: Consult us first, if you also wish to embed other uncoated component types!	3 "Embedding of capacitors in finished assemblies"



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Symbols and terms

Symbol	English	German
α	Heat transfer coefficient	Wärmeübergangszahl
α _c	Temperature coefficient of capacitance	Temperaturkoeffizient der Kapazität
Α	Capacitor surface area	Kondensatoroberfläche
βc	Humidity coefficient of capacitance	Feuchtekoeffizient der Kapazität
С	Capacitance	Kapazität
C _R	Rated capacitance	Nennkapazität
ΔC	Absolute capacitance change	Absolute Kapazitätsänderung
$\Delta C/C$	Relative capacitance change (relative	Relative Kapazitätsänderung (relative
	deviation of actual value)	Abweichung vom Ist-Wert)
$\Delta C/C_R$	Capacitance tolerance (relative deviation from rated capacitance)	Kapazitätstoleranz (relative Abweichung vom Nennwert)
dt	Time differential	Differentielle Zeit
Δt	Time interval	Zeitintervall
ΔT	Absolute temperature change	Absolute Temperaturänderung
	(self-heating)	(Selbsterwärmung)
∆tan δ	Absolute change of dissipation factor	Absolute Änderung des Verlustfaktors
ΔV	Absolute voltage change	Absolute Spannungsänderung
dV/dt	Time differential of voltage function (rate	Differentielle Spannungsänderung
	of voltage rise)	(Spannungsflankensteilheit)
$\Delta V / \Delta t$	Voltage change per time interval	Spannungsänderung pro Zeitintervall
E	Activation energy for diffusion	Aktivierungsenergie zur Diffusion
ESL	Self-inductance	Eigeninduktivität
ESR	Equivalent series resistance	Ersatz-Serienwiderstand
f	Frequency	Frequenz
f ₁	Frequency limit for reducing permissible	Grenzfrequenz für thermisch bedingte
	AC voltage due to thermal limits	Reduzierung der zulässigen
		Wechselspannung
f ₂	Frequency limit for reducing permissible	Grenzfrequenz für strombedingte
	AC voltage due to current limit	Reduzierung der zulässigen
		Wechselspannung
f _r	Resonant frequency	Resonanzfrequenz
F _D	Thermal acceleration factor for diffusion	Therm. Beschleunigungsfaktor zur Diffusion
F _τ	Derating factor	Deratingfaktor
i	Current (peak)	Stromspitze
I _c	Category current (max. continuous	Kategoriestrom (max. Dauerstrom)
	current)	



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Symbol	English	German
I _{RMS}	(Sinusoidal) alternating current,	(Sinusförmiger) Wechselstrom
	root-mean-square value	
i _z	Capacitance drift	Inkonstanz der Kapazität
k _o	Pulse characteristic	Impulskennwert
Ls	Series inductance	Serieninduktivität
λ	Failure rate	Ausfallrate
λο	Constant failure rate during useful	Konstante Ausfallrate in der
	service life	Nutzungsphase
λ_{test}	Failure rate, determined by tests	Experimentell ermittelte Ausfallrate
P_{diss}	Dissipated power	Abgegebene Verlustleistung
P _{gen}	Generated power	Erzeugte Verlustleistung
Q	Heat energy	Wärmeenergie
ρ	Density of water vapor in air	Dichte von Wasserdampf in Luft
R	Universal molar constant for gases	Allg. Molarkonstante für Gas
R	Ohmic resistance of discharge circuit	Ohmscher Widerstand des
		Entladekreises
Ri	Internal resistance	Innenwiderstand
R _{ins}	Insulation resistance	Isolationswiderstand
R _P	Parallel resistance	Parallelwiderstand
Rs	Series resistance	Serienwiderstand
S	severity (humidity test)	Schärfegrad (Feuchtetest)
t	Time	Zeit
Т	Temperature	Temperatur
τ	Time constant	Zeitkonstante
tan δ	Dissipation factor	Verlustfaktor
$\tan \delta_D$	Dielectric component of dissipation factor	Dielektrischer Anteil des Verlustfaktors
tan δ _P	Parallel component of dissipation factor	Parallelanteil des Verlfustfaktors
tan δ _s	Series component of dissipation factor	Serienanteil des Verlustfaktors
T _A	Ambient temperature	Umgebungstemperatur
T _{max}	Upper category temperature	Obere Kategorietemperatur
T _{min}	Lower category temperature	Untere Kategorietemperatur
t _{OL}	Operating life at operating temperature	Betriebszeit bei Betriebstemperatur und
	and voltage	-spannung
T _{op}	Operating temperature	Beriebstemperatur
T _R	Rated temperature	Nenntemperatur
T _{ref}	Reference temperature	Referenztemperatur
t _{sL}	Reference service life	Referenz-Lebensdauer
V _{AC}	AC voltage	Wechselspannung



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Symbol	English	German
V _c	Category voltage	Kategoriespannung
V _{C,RMS}	Category AC voltage	(Sinusförmige)
		Kategorie-Wechselspannung
V _{CD}	Corona-discharge onset voltage	Teilentlade-Einsatzspannung
V_{ch}	Charging voltage	Ladespannung
V_{DC}	DC voltage	Gleichspannung
V_{FB}	Fly-back capacitor voltage	Spannung (Flyback)
Vi	Input voltage	Eingangsspannung
Vo	Output voltage	Ausgangssspannung
V _{op}	Operating voltage	Betriebsspannung
V _p	Peak pulse voltage	Impuls-Spitzenspannung
V_{pp}	Peak-to-peak voltage Impedance	Spannungshub
V _R	Rated voltage	Nennspannung
ν̂ _R	Amplitude of rated AC voltage	Amplitude der Nenn-Wechselspannung
V _{RMS}	(Sinusoidal) alternating voltage,	(Sinusförmige) Wechselspannung
	root-mean-square value	
V_{sc}	S-correction voltage	Spannung bei Anwendung "S-correction"
V_{sn}	Snubber capacitor voltage	Spannung bei Anwendung
		"Beschaltung"
Z	Impedance	Scheinwiderstand
е	Lead spacing	Rastermaß

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